

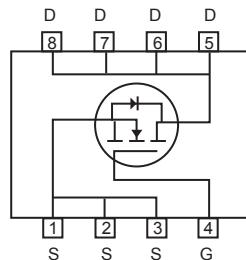
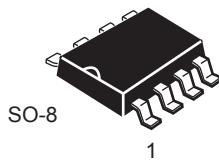


# CEM3082

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- 30V, 12A,  $R_{DS(ON)} = 10.5\text{m}\Omega$  @  $V_{GS} = 10\text{V}$ .  
 $R_{DS(ON)} = 15.0\text{m}\Omega$  @  $V_{GS} = 4.5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Lead free product is acquired.
- Surface mount Package.



### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	12	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	50	A
Maximum Power Dissipation	$P_D$	2.5	W
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Ambient <sup>b</sup>	$R_{\theta JA}$	50	$^\circ\text{C/W}$



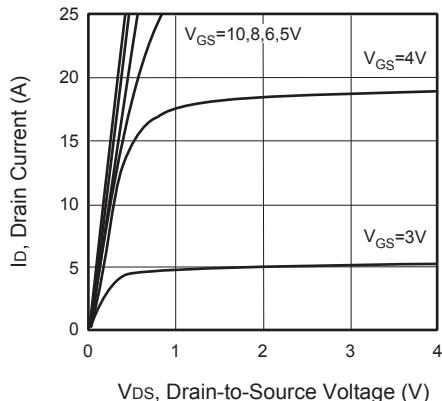
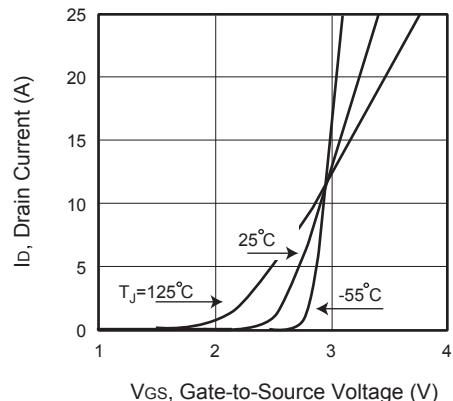
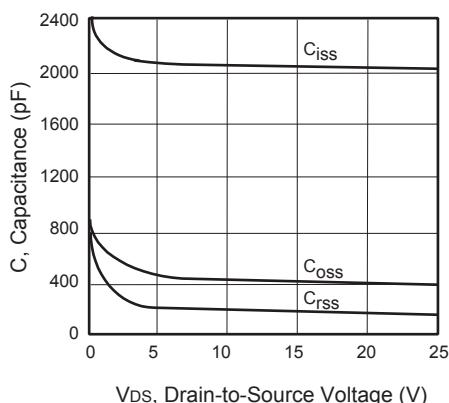
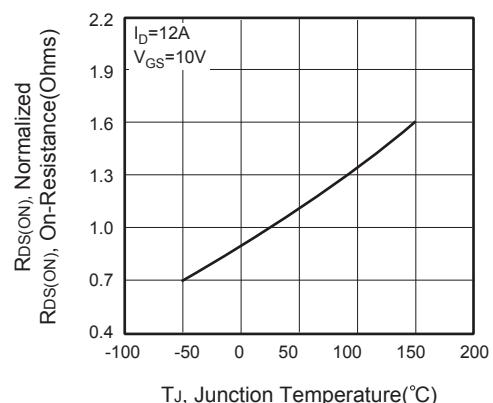
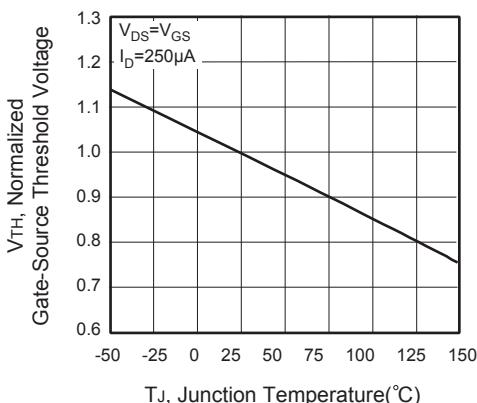
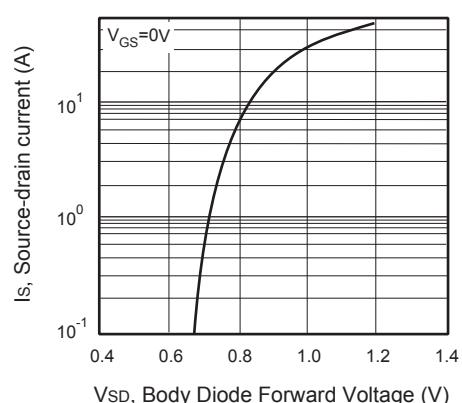
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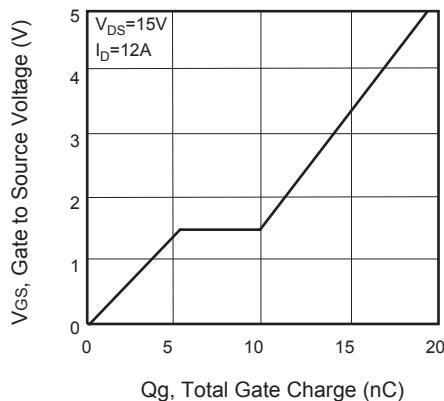
## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$		1		$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>On Characteristics</b> <sup>c</sup>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	1		3	V
Static Drain-Source	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 12\text{A}$		8.5	10.5	$\text{m}\Omega$
On-Resistance		$V_{\text{GS}} = 4.5\text{V}, I_D = 10\text{A}$		11	15	$\text{m}\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 5\text{V}, I_D = 10\text{A}$		18		S
<b>Dynamic Characteristics</b> <sup>d</sup>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		2115		pF
Output Capacitance	$C_{\text{oss}}$			410		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			265		pF
<b>Switching Characteristics</b> <sup>d</sup>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 15\text{V}, I_D = 1\text{A}, \square$ $V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		15	30	ns
Turn-On Rise Time	$t_r$			9	18	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			45	90	ns
Turn-Off Fall Time	$t_f$			15	30	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 15\text{V}, I_D = 12\text{A}, V_{\text{GS}} = 5\text{V}$		19.6	26	nC
Gate-Source Charge	$Q_{\text{gs}}$			6.5		nC
Gate-Drain Charge	$Q_{\text{gd}}$			6.0		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current <sup>b</sup>	$I_S$				4.5	A
Drain-Source Diode Forward Voltage <sup>c</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 4.5\text{A}$			1.0	V

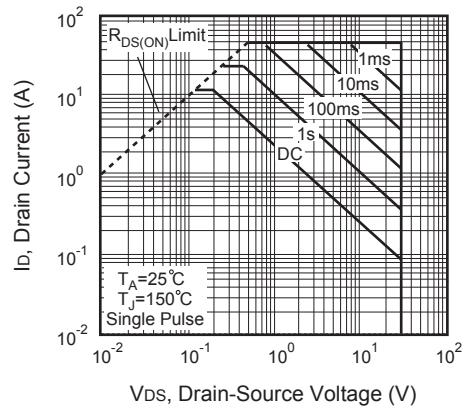
Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature. $\square$
- b.Surface Mounted on FR4 Board,  $t \leq 10 \text{ sec.}$  $\square$
- c.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ . $\square$
- d.Guaranteed by design, not subject to production testing. $\square$

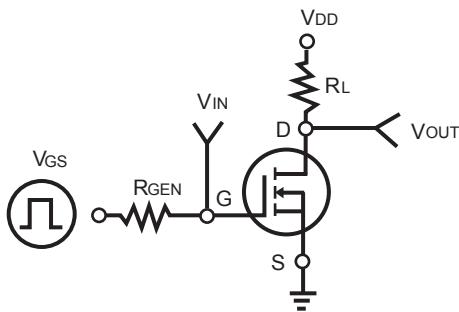
**Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. Capacitance****Figure 4. On-Resistance Variation with Temperature****Figure 5. Gate Threshold Variation with Temperature****Figure 6. Body Diode Forward Voltage Variation with Source Current**



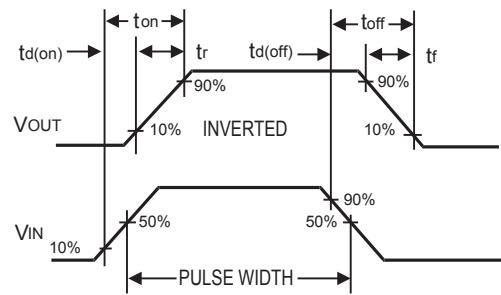
**Figure 7. Gate Charge**



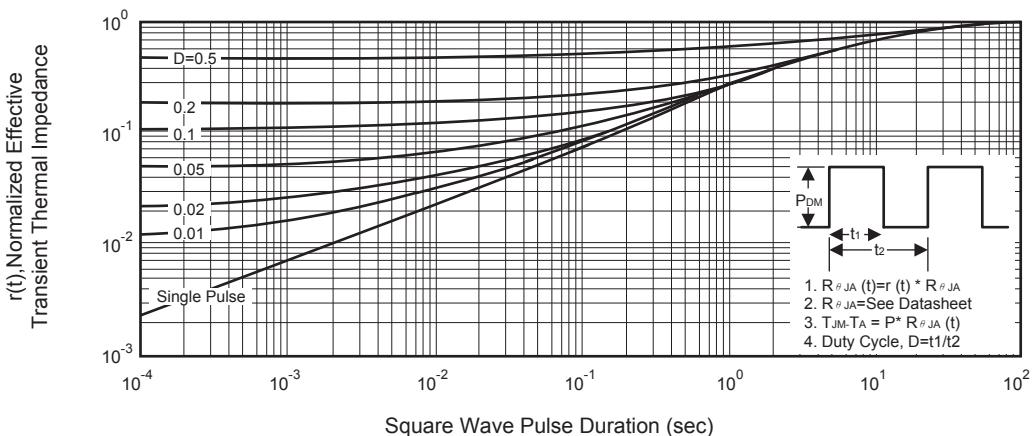
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Switching Test Circuit**



**Figure 10. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**